



Industrial Computing Platform Partner

AMC-263 (FSB-866G)

Environment Test Report

Report NO: 06I020004

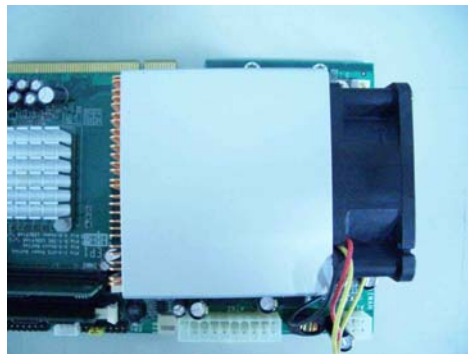
Issued by: Rex-Chang / 06/07/2006
Test Engineer Date

Reviewed by: Wenyuan Yang / 06/07/2006
Manager Date

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Num	Item	Spec
1.	Control Box:	AMC- 263 / 6 Slot Wall Mount Chassis
	1. Main Board	AAEON FSB-866G Rev. A1.0 (BIOS: 1.0)
	2. CPU	Intel Pentium(R) 4 / 3.2 GHz
	3. Memory	DIMM1: 256MB Hynix HY5DU56822BT-J (DDR333) DIMM2: 128MB Hynix HY5DU561622DT-J (DDR333)
	4. Power Supply	Shen Jang 300S/1U (ATX)
	5. HDD	Maxtor DiamondMax Plus 9 / 80GB (ATA/133)
	7. FDD	TEAC FD-235HF

CPU Cooler



Test Date: 05-30-2006 ~ 06-02-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

Test Standard: Reference IEC68-2-14 Testing procedures
Test N: Change of temperature Test

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4L+-100
Date of Calibration: 11/21/05
Serial Number: 2582

Temperature Measurement:

40 Channel Thermal Recorder:
YOKOGAWA Inc,
Model: DA100-13-1D
Date of Calibration: 12/14/05
Serial Number: 12A323190

Test Condition:

1. Test Low Temperature: 0°C (1~4 cycles)
-5°C (5th cycle)
2. Test High Temperature: 50°C (1~4 cycles)
55°C (5th cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 5 cycles
6. Test Environment Curve:

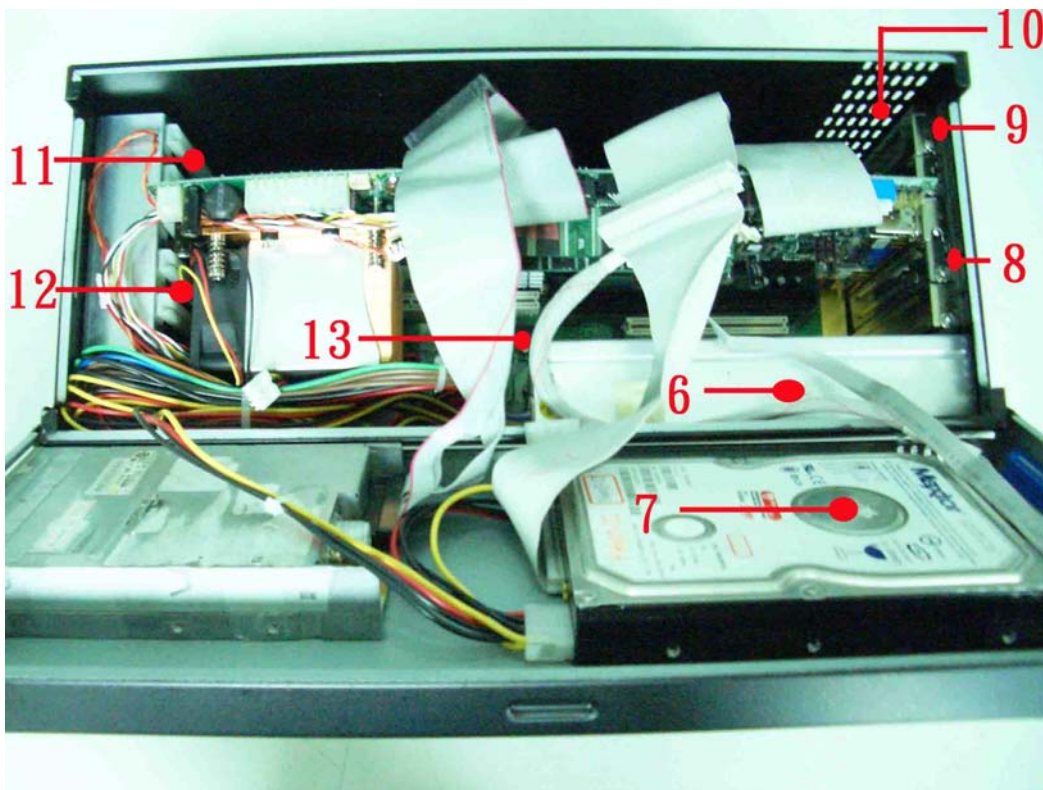
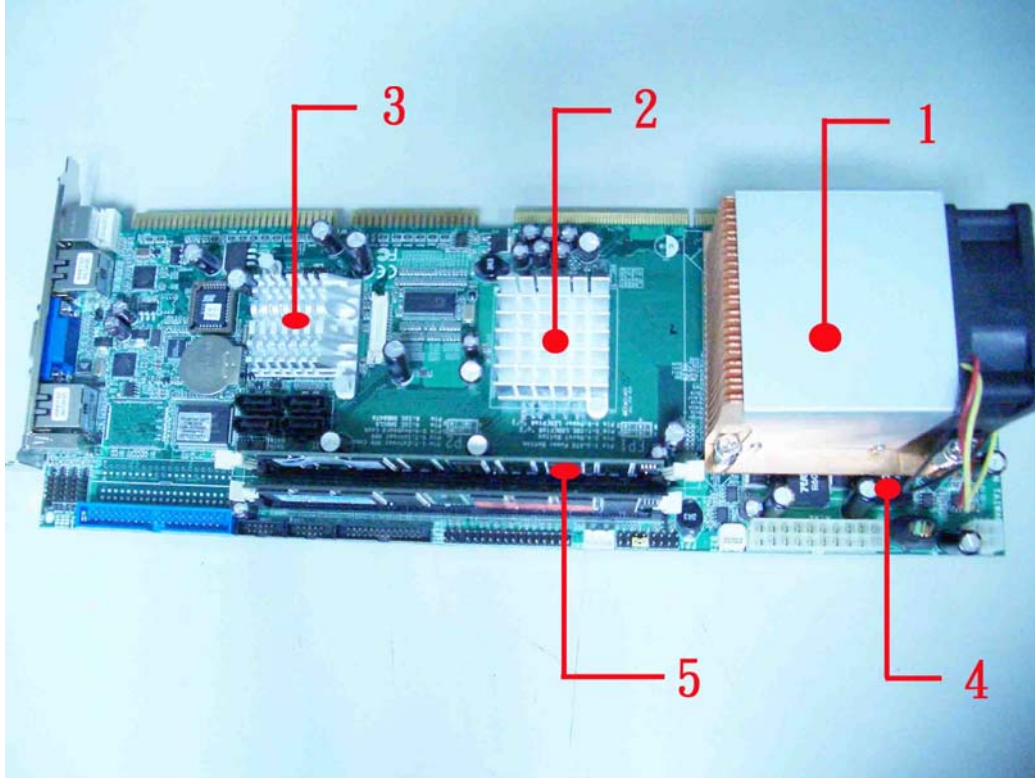
Temperature cycle test

Test O.S. / Software:

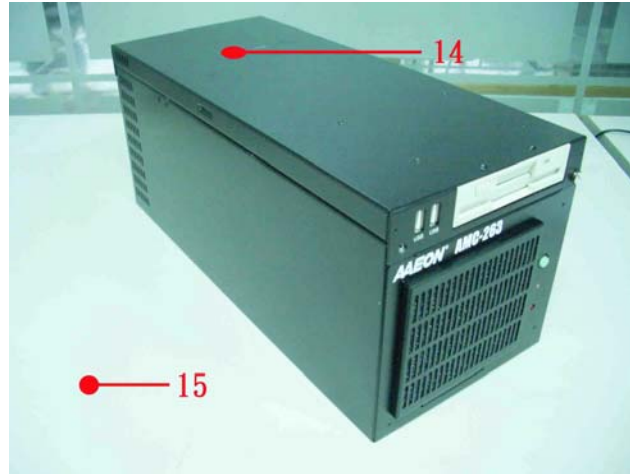
Windows 2000 / Run PassMark Burn In Test Pro 4.0

Temperature Recorder:

Measuring Thermal Couple Position :



Temperature cycle test



Thermal profile data:

AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Point	Temp. Stage(°C)	Spec	55	50	25	0	-5
1. CPU Surface		70.8	79.6	74.6	49.6	24.6	19.6
2. U22 - INTEL.NG82915GV-SL8BT Heat Sink Surface		99	84.5	79.5	54.5	29.5	24.5
3. U23 - INTEL.FW82801FB SL7Y5 Heat Sink Surface		95	76.7	71.7	46.7	21.7	16.7
4. L10 - (TF)COIL.0.6uH.DIP Wire Size 1.1*2mm.2wire 35.TRIO.PSG-1410-R60M1		85	102.8	97.8	72.8	47.8	42.8
5. Memory		70	72.0	67.0	42.0	17.0	12.0
6. Power Supply Surface		50	69.8	64.8	39.8	14.8	9.8
7. HDD Surface		55	69.1	64.1	39.1	14.1	9.1
8. Control Box Inside Air Temperature - 1		N/A	67.8	62.8	37.8	12.8	7.8
9. Control Box Inside Air Temperature - 2		N/A	63.3	58.3	33.3	8.3	3.3
10. Control Box Inside Air Temperature -3		N/A	66.6	61.6	36.6	11.6	6.6
11. Control Box Inside Air Temperature -4		N/A	60.7	55.7	30.7	5.7	0.7
12. Control Box Inside Air Temperature -5		N/A	62.5	57.5	32.5	7.5	2.5
13. Control Box Inside Air Temperature -6		N/A	65.1	60.1	35.1	10.1	5.1
14. Control Box External Surface		N/A	63.6	58.6	33.6	8.6	3.6
15. Chamber Air Temperature		N/A	54.9	49.9	24.9	-0.1	-5.1

1. Tm (Measured operation temperature) must less than Tc (Specified case temperature) + 5 degree C.
 2. Any Tm value showed in red words which meaning the value over the Tc + 5 degree C of this device specification.

Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

No problem was found during the temperature operation cycle test. But there have three location temperature are over spec. and the detail information as below.

1. L10 (TF.COIL.0.6uH.DIP Wire Size 1.1*2mm.2wire 35.TRIO.PSG-1410-R60M1).
2. Power Supply
3. HDD

Test Date: 05-13~15-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

Test Standard: Reference IEC 68-2-2 Testing procedures
Test Bd: Dry Heat Test (Operation)

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4L+-100
Date of Calibration: 11/21/05
Serial Number: 2582

Testing Item:

1. Test Temperature: 50°C
2. Test Times: 48Hrs
3. Test Software: Windows XP / Run PassMark Burn In Test Pro 4.0
4. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

No problem was found during the high temperature operation test.

Test Date: 05-05~06-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

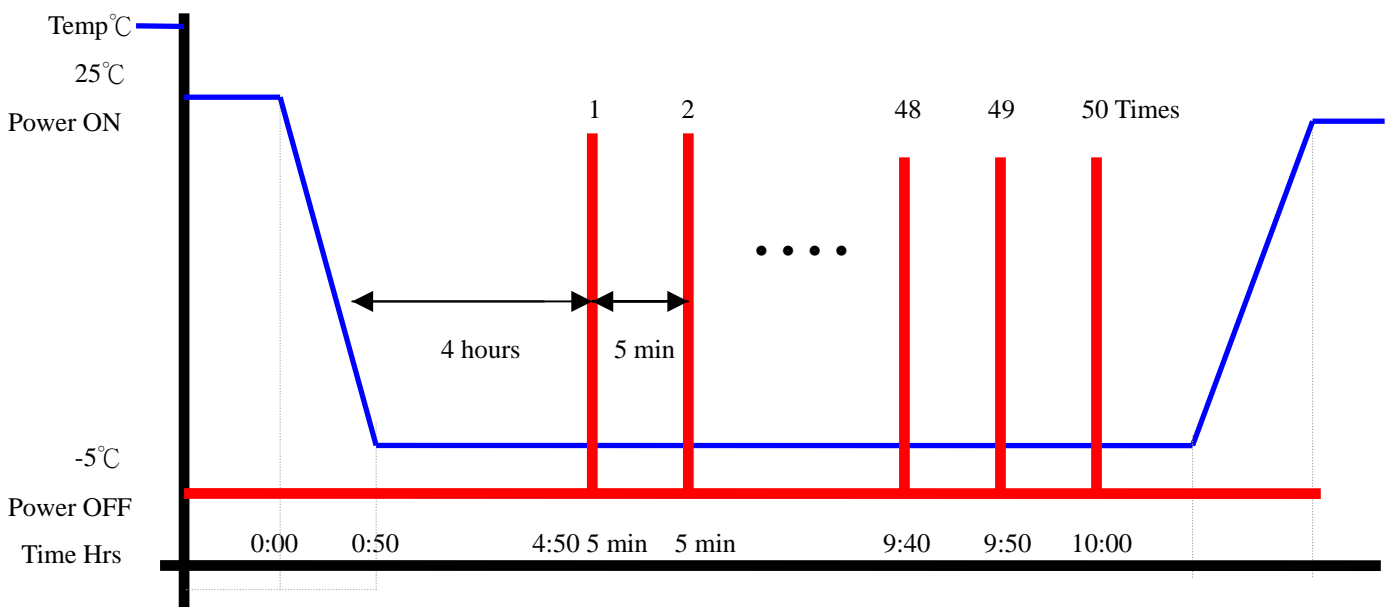
Test Standard: Reference IEC 68-2-1 Testing procedures
Test Ab: Cold Test

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4L+-100
Date of Calibration: 11/21/05
Serial Number: 2582

Test Condition:

1. Test Temperature: -5°C
2. Test Times: 5 Hours or 50 times of ON/OFF
 - (1) Power off for 4 hours before 1'st power on. Then once complete boot, power off immediately.
 - (2) After 5 min later power on again and wait until booting is completed.
 - (3) Repeat (2) for around 4:50
 - (4) Power off then wait for 5 min before final power on operation.
3. Number of test: 50 times
4. Test Software: Windows XP (Simplified Chinese)
5. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

Passed.

Test Date: 06-02~05-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

Test Standard: Reference IEC 68-2-2 Testing procedures
Test Bb: Dry Heat Test (Non-operation)

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4L+-100
Date of Calibration: 11/21/05
Serial Number: 2582

Testing Item:

1. Test Temperature: 60°C
2. Test Times: 48Hrs
3. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

No problem was found after the high temperature storage test.

Test Date: 05-27~29-2006

Test Product: AMC-263 / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

Test Standard: Reference IEC 68-2-2 Testing procedures
Test Bb: Dry Heat Test (Non-operation)

Test Equipment:

K.SON. INS. TECH. CORP.
Model: THS-D4H+-100
Date of Calibration: 05/19/06
Serial Number: 1241

Testing Item:

1. Test Temperature: 80°C
2. Test Times: 48Hrs
3. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

No problem was found after the high temperature storage test.

Test Date: 05-25~27-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

Performed By: Rex Chang

Test Standard: Reference IEC 68-2-1 Testing procedures
Test Ab: Cold Test (Non-operation)

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4H+-100
Date of Calibration: 05/19/06
Serial Number: 1241

Testing Item:

1. Test Temperature: -20°C
2. Test Times: 48Hrs
3. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:

No problem was found after the low temperature storage test.

Test Date: 05-22~25-2006

Test Product: AMC-263 (FSB-866G A1.0) / 6 Slot Wall Mount Chassis

Test Site: AAEON QA Internal Lab.

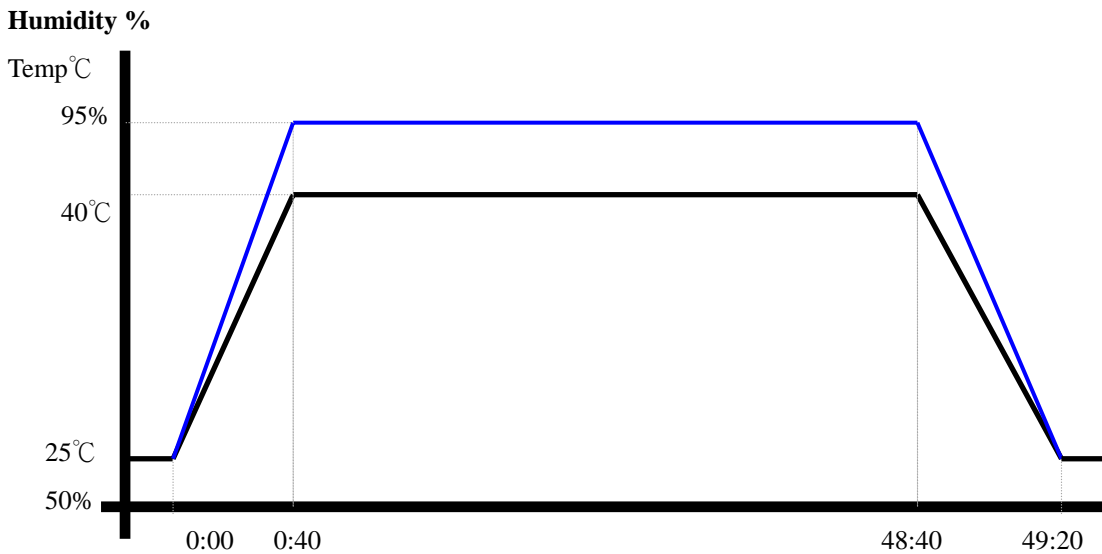
Performed By: Rex Chang

Test Standard: Reference IEC 68-2-3 Testing procedures
Test Ca: Damp heat, steady state (Non-operation)

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-D4H+-100
Date of Calibration: 05/19/06
Serial Number: 1241

Testing Item:

1. Test Temperature: 40°C
2. Test Humidity: 95%RH
3. Test Times: 48Hrs
4. Test Environment Curve:



Sample Configuration & Quantity Under Test:
Quantity: 1 (AMC-263 / 6 Slot Wall Mount Chassis)

Test Result:
No problem was found after the humidity storage test.